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 3-State Buffer-Type Outputs Drive Bus	DW OR NT PACKAGE
Lines Directly	(TOP VIEW)
 Each Register File Has Individual	S0 $\begin{bmatrix} 1 & 24 \end{bmatrix}$ V _{CC}
Write-Enable Controls and Address Lines	1A0 $\begin{bmatrix} 2 & 23 \end{bmatrix}$ S1
 Designed Specifically for Multibus	1A1 []3 22 [] 2A3
Architecture and Overlapping File	1A2 []4 21 [] 2A2
Operations	1A3 []5 20 [] 2A1
 Prioritized B-Input Port Prevents Write	1 W []6 19] 2A0
Conflicts During Dual-Input Mode	S2 []7 18] 2W
 Package Options Include Plastic	DQA1 []8 17] S3
Small-Outline (DW) Packages and Standard	DQA2 []9 16] DQB4
Plastic (NT) 300-mil DIPs	DQA3 []10 15] DQB3
lescription	DQA4 [11 14] DQB2 GND [12 13] DQB1

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This device features two 16-word by 4-bit register

files. Each register file has individual write-enable

(1W, 2W) controls and address lines. This device has two 4-bit data I/O ports (DQA1–DQA4 and DQB1–DQB4). The data I/O ports can output to bus A and bus B, receive input from bus A and bus B, receive input from bus A and output to bus B, or output to bus A and receive input from bus B. To prevent writing conflicts in the dual-input mode, the B-input port takes priority. Two select (S0 and S1) lines control which port has access to which register. S2 determines whether the A ports are in the input or the output modes and S3 does likewise for the B ports. The address lines (1A0-1A3 or 2A0-2A3) are decoded by an internal 1-of-16 decoder to select which register word is to be accessed. All outputs are 3-state buffer-type outputs designed specifically to drive bus lines directly.

The SN74ALS870 is characterized for operation from 0°C to 70°C.

FILE SELECT			INPUT/OUTPUT						
S0	S1	FILE SEL	S2	S3	I/O SEL				
L	L	1R to A, 1R to B							
н	L	2R to A, 1R to B				L	A out P out		
L	н	1R to A, 2R to B		L	A out, B out				
н	Н	2R to A, 2R to B							
L	L	A to 1R, 1R to B							
н	L	A to 2R, 1R to B		L		ΗL	A in Rout		
L	Н	A to 1R, 2R to B			A in, B out				
н	Н	A to 2R, 2R to B							
L	L	1R to A, B to 1R		Н					
н	L	2R to A, B to 1R			н	ц	ц	ц	A out, B in
L	Н	1R to A, B to 2R				A Out, B III			
н	Н	2R to A, B to 2R							
L	L	B to 1R							
н	L	A to 2R, B to 1R	н	н		A in D in			
L	Н	A to 1R, B to 2R			A in, B in				
н	Н	B to 2R							

FUNCTION TABLE

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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logic diagram (positive logic)

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Input voltage, V _I : All inputs	7 V
I/O ports	5.5 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



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recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	Supply voltage			5	5.5	V
VIH	High-level input voltage		2			V
VIL	Low-level input voltage				0.8	V
ЮН	High-level output current				-2.6	mA
I _{OL}	Low-level output current				24	mA
tw	Pulse duration, write		12			ns
	Setup time	Address before write \downarrow	5			
t _{su}		Data before write↑	15			ns
		Select before write \downarrow	12			
	Hold time Data before write	Address before write \downarrow	0			
th		Data before write↑	0			ns
		Select before write \downarrow	12			
ТА	Operating free-air temperature		0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	түр†	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lı = –18 mA			-1.2	V
V _{OH}		V _{CC} = 4.5 V to 5.5 V,	I _{OH} = -0.4 mA	V _{CC} -2			v
		V _{CC} = 4.5 V,	I _{OH} = -2.6 mA	2.4	3.2		v
VOL		V _{CC} = 4.5 V,	I _{OL} = 24 mA		0.35	0.5	V
1.	Control inputs	V _{CC} = 5.5 V	V _I = 7 V			0.1	~ ^
ΙI	DQA and DQB ports		V _I = 5.5 V			0.2	mA
	1W and 2W	V _{CC} = 5.5 V,				20	
Iн	Other control inputs		V _I = 2.7 V			40	μA
	DQA and DQB ports [‡]					50	
1.	Control inputs	V _{CC} = 5.5 V,				-0.2	A
ηΓ	DQA and DQB ports [‡]		VI =0!4′ V			-0.2	mA
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA
ICC		$V_{CC} = 5.5 V$			80	110	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. [‡] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current. [§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	$\label{eq:CC} \begin{array}{l} V_{CC} = 4.5 \ V \ to \ 5.5 \\ C_L = 50 \ pF, \\ R1 = 500 \ \Omega, \\ (OUTPUT) \\ T_A = MIN \ to \ MAX \end{array}$;),),	UNIT
			MIN	MAX	
^t a(A)	Any A	Any DQ	3	19	ns
t (0)	SO	Any DQA	3	15	ns
^t a(S)	S1	Any DQB	3	15	
4	S2	Any DQA	3	14	ns
^t dis	S3	Any DQB	3	14	
	S2	Any DQA	3	17	
ten	S3	Any DQB	3	17	ns
	W	Any DQ	5	23	
^t pd	DQA	DQB	5	26	ns
	DQB	DQA	5	26	1

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_{f} = t_{f} = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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